DOT MATRIX LIQUID CRYSTAL DISPLAY MODULE

G12232-28 Serial

USER' MANUAL

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PROPO	SED BY	APPROVED
Design	Approved	



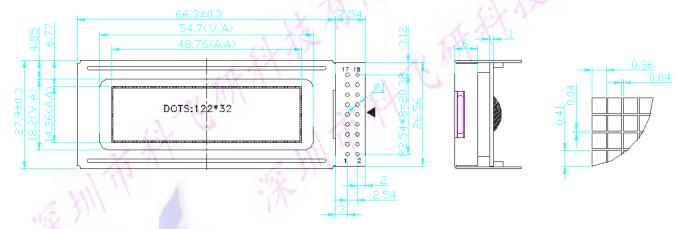
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	深圳市科技和市科	

1. Mechanical Specification

ITEM	STA	NDARD VALUE		UNIT					
DOT MATRIX FORMAT	1:	122 X 32 DOTS							
MODULE DIMENSION	73. 85 (W) X 28.0 (H) X 17	.0((T))		mm					
VIEWING DISPLAY AREA	55.	0 (W) X 18.2 (H)		mm					
ACTIVE DISPLAY AREA	48.73	3 (W) X 14. 36 (H)		mm					
DOT SIZE	0.30	6 (W) X 0.41 (H)		mm					
DOT PITCH	0.40	0.40 (W) X 0.45 (H)							
	STN/黄绿膜黑字/LED底部	黄绿光	1112						
			4						
			A						
		V	A STATE OF THE STA	mA					
		V		Hz					
BACKLIGHT Half-Lift TIME		Α		HR.					
LED Backlight Color		WHITE	A	113					
Backlight Input	DC +5.0V	V	150	Ma					
BACKLIGHT Half-Lift TIME		100,000	K VV	HR.					

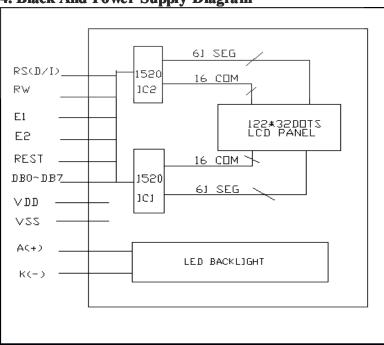
2. Mechanical Diagram



3. Interface Pin Connections

No.	Symbol	Level	Function
1	A(+)	+5.0V	LED+ (Backlight 1)
2	K(-)	0V	LED- (Backlight 2)
3	DB6	H/L	Data Bit 6
4	DB7	H/L	Data Bit 7
5	DB4	H/L	Data Bit 4
6	DB5	H/L	Data Bit 5
7	DB2	H/L	Data Bit 2
8	DB3	H/L	Data Bit 3
9	DB0	H/L	Data Bit 0
10	DB1	H/L	Data Bit 1
11	R/W	H/L	H:READ(LCM MPU) L:WRITE(MPU LCM)
12	A0 (RS)	H/L	Data / Instruction code
13	E1	Н,Н→L	Chip select for IC1
14	E2	Н,Н→L	Chip select for IC2
15	VO	H/L	Contrast Adjust
16	RST(/RST)	H/L	RST:68 serial,/RST:80serial
17	VDD	-	DC+5V
18	VSS		GND (0V)

4. Black And Power Supply Diagram



5. Environmental absolute maximum ratings

ITEM	OPER.	ATING	STOR	RAGE	REMARKS		
	MIN. MAX.		MIN.	MAX.			
Ambient Temperature	0 /-20°C	+50/+70 °C	-20/-30 °C	+70/+80 °C	NOTE 1		
Humi dity	NO	ГЕ 1	NO	ΓE 2	Without Condensation		
Vibration		$4.9 \mathrm{m/s^2}$		19.6m/s ²	XYZ Directions		
Shock		29.4 m/s ²		490.0m/s ²	XYZ Directions		

Remarks:

NOTE (1): Ta at 60 °C: 50 HR Max. NOTE (2): Ta < 40 °C: 95% RH Max.

Ta > $40 \,^{\circ}$ C: Absolute humidity must be lower than the humidity of 95% at $40 \,^{\circ}$ C.

6. Electrical Characteristics

ITEM	SYN	CONDITION	MIN.	TYPE	MAX.	UNIT
SUPPLY VOLTAGE FOR LOGIC	VDD-VSS		4.5	5.0	5.5	V
SUPPLY VOLTAGE FOR LCD	VDD-VO	Ta= 25 °C	0	The same	1.50	V
INPUT HIGH VOLTAGE	VIH		0.7VDD		VDD	V
INPUT LOW VOLTAGE	VIL	- 1	0		0.3VDD	V
SUPPLY CURRENT (LOGIC)	IDD	VDD=+5V,VO=5V		-4	2.0	mA

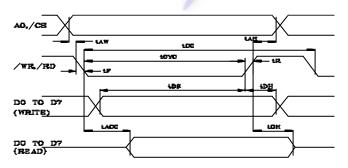
7. Electro-Optical Characteristics

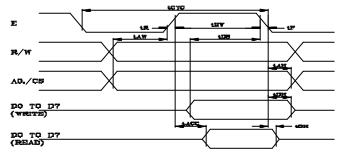
ITEM	SYM	TEMP (°C)	MIN.	ТҮРЕ	MAX.	UNIT
RESPONSE TIME	tr	0/-20		400/2450		ms
	tr	25	- 4	150		ms
	tf	0/-20	- AL K	1000/2088		ms
	tf	25	1-1-1	300		ms
FRAME FREQUENCY	fF		X6X			Hz
OPERATING VOLTAGE	1.0	0	5.8	6.2	6.6	V
3/ 7	Vop	25	5.4	5.8	6.2	V
130		50	5.0	5.4	5.8	V
VIEWING ANGLE F-B	Ai	- //-	55	-		deg
R-L	Qi		60	-		deg
CONTRAST RATIO	K	25		22.8		

8. Timing Control

MPU Bus Read/Write(80-family MPU)

MPU Bus Read/Write(68-family MPU)





Item		Symbol	Li mit (Min.)	Limit (Max.)	Unit
System cycle tin	ne	tCYC	1000		ns
Address setup ti	me	tAW	20		ns
Address hold tin	ne	tAH	10		ns
Control pulse wi	dth	tCC	200		ns
Data setup tim	e	tDS	80	80	
Data hold time	;	tDH	10		ns
Output disable ti	me	tOH	10	60	ns
READ access ti	ne	tACC		90	ns
Enable	Enable Read		100		ns
Pulse width	Pulse width Write		80		ns
Rise and Fall tir	ne	tR,tF		15	ns

9. Instruction Set

Command						Code)					Function				
	A0	/RD	/WR	D7	D6	D5	D4	D3	D2	D1	D0					
Display On/Off	0	1	0	1	0	1	0	1	1	1	0/1	Turns display on or off. 1:ON, 0:OFF.				
Display start line	0	1	0	1	1	0	Disp	olay st	art ad	dress (0 to	Specifies RAM line corresponding to				
									31)			top line of display.				
Set page address	0	1	0	1	0	1	1	1	0	Pa	ıge	Sets display RAM page in page address				
											o 3)	register.				
Set column	0	1	0	0		Colı	ımn a	ddress	(0 to	79)		Sets display RAM column address in				
(segment address)												column address register.				
							R					Read the following status:				
						ON	Е					BUSY 1:Busy 0:Ready				
Read status	0	0	1	Busy	ADC	/	S	0	0	0	0	ADC 1:CW output 0:CCW output				
						OFF	Е					ON/OFF 1:Display off 0:Display on				
							T					RESET 1:Being reset 0:Normal				
Write display data	1	1	0				Write	e data				Writes data from data bus into display				
												RAM.				
Read display data	1	0	1				Read	d data				Reads data from display RAM onto				
												data bus.				
Select ADC	0	1	0	1	0	1	0	0	0	0	0/1	0:CW output. 1:CCW output.				
Static drive On/Off	0	1	0	1	0	1	0	0	1	0	0/1	Selects static driving operation.				
									1	V	4	1: Static drive. 0:Normal driving.				
Select duty	0	1	0	1	0	1	0	1	0	0	0/1	Selects LCD duty cycle				
								10	. //			1:1/32, 0:1/16.				
Read-Modify-Write	0	1	0	1	1	1	0	0	0	0	0	Read-modify-write ON.				
End	0	1	0	1	1	1	0	1	1	1	0	Read-modify-write OFF.				
Reset	0	1	0	1	1	1	0	0	0	1	0	Software reset.				

10. Description of Instructions

10.1 Command list

(1) Display ON/OFF

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	1	0	1	0	(\ 1\\\)	0	1	1	1	D

This command turns the display on and off.

D = 1: Display ON. D = 0: Display OFF.

(2) Display start line

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	_
Code	0	1	0	1	1	0	A4	A3	A2	A1	A0	ı

This command specifies the line address (10.2) and indicates the display line that corresponds to COMO. The display area begins at the specified line address and continues in the line address increment direction. The area having the number of lines of the specified display duty is displayed. If the line address is changed dynamically by this command, the vertical smooth scrolling and paging can be used.

A4	A3	A2	A1	A0	Line address
0	0	0	0	0	0
0	0	0	0	1	1
:	:	:	:	:	:
:	:	:	:	:	:
1	1	1	1	1	31

(3) Set page address

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	1	0	1	0	1	1	1	0	A1	A0

This command specifies the page address that corresponds to the low address of the display data RAM when it is accessed by the MPU. Any bit of the display data RAM can be accessed when it is page address and column address are specified. The display status is not changed even when the page address is changed.

A1	A0	Page
0	0	0
0	1	1
1	0	2
1	1	3

(4) Set column address

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	1	0	0	A6	A5	A4	A3	A2	A1	A0

This command specifies a column address of the display data RAM. When the display data RAM is accessed by the MPU continuously, the column address is incremented by 1 each time it is accessed from the set address. Therefore, the MPU can access to data continuously. The column address stops to be incremented at address 80, and the page address is not changed continuously.

A6	A5	A4	A3	A2	A1	A0	Column address
0	0	0	0	0	0	0	0
0	0	0	0	0	0	1	/(\1\'
:	:	:	:	: (()	4:	:	V (V)
1	0	0	1	11	1	1	79

(5) Status Read

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	0	1	BUSY	ADC	ON/OFF	RESET	0	0	0	0

Reading the command I/O register (A0=0) yields system status information.

The BUSY bit is indicates whether the driver will accept a command or not.

Busy = 1: The driver is currently executing a command or is resetting. No new command will be accepted.

Busy = 0: The driver will accept a new command.

• The ADC bit indicates the way column address are assigned to segment drivers.

ADC = 1: Normal. Column address n -> segment driver n.

ADC = 0: Inverted. Column address 79-n -> segment driver n.

The ON/OFF bit indicates the current status of the display.
 ON/OFF = 1: Display OFF. ON/OFF = 0: Display ON.

• The RESET bit indicates whether the driver is executing a hardware or software reset or if it in normal operating mode.

RESET = 1: Currently executing reset command. RESET = 0: Normal operation.

(6) Write Display Data

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	1	1	0				Write	e data			

Writes 8-bits of data into the display data RAM, at location specified by the contents of the column address and page address registers and then increments the column address register by one.

(7) Read Display Data

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	1	0	1				Read	data	-		

Read 8-bits of data from the data I/O latch, updates the contents of the I/O latch with display data from the display data RAM location specified by the contents of the column address and page address registers and then increments the column address register.

After loading a new address into the column address register one dummy read is required before valid data is obtained.

(8) Select ADC

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	1	0	1	0	1	0	0	0	0	D

This command selects the relationship between display data RAM column addresses and segment drivers. $D=1:SEG0 \leftarrow column$ address 4FH, (inverted). $D=0:SEG0 \leftarrow column$ address 00H, (normal). This command is provided to reduce restrictions on the placement of driver ICs and routing of traces during printed circuit board design.

(9) Select drive On/Off

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	1	0	1	0	1	0	0	1	0	D

Forces display on and all common outputs to be selected.

D = 1: Static drive on. D = 0: Static drive off.

(10) Select duty

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	1	0	1	0	1	0	1	0	0	D

D = 1 : 1/32 duty cycle. D = 0 : 1/16 duty cycle.

(11) Read-Modify-Write

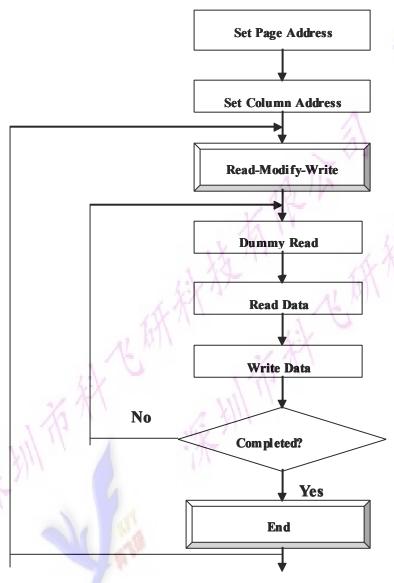
	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Code	0	1	0	1	1	1	0	0	0	0	0

This command defeats column address register auto-increment after data reads. The current contents of the column address register are saved. This mode remains active until an End command is received.

• Operation sequence during cursor display

When the End command is entered, the column address is returned to the one used during input of Read-Modify-Write command. This function can reduce the load MPU when data change is repeated at a specific display area (such as cursor blinking).

Any command other than Data Read or Write can be used in the Read-Modify-Write mode. However, the Column Address Set command cannot be used.

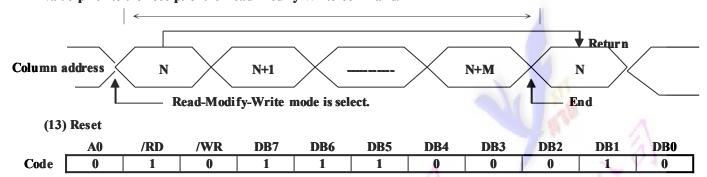


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(12) End

	A0	/RD	/WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
Code	0	1	0	1	1	1	0	1	1	1	0	ı

This command cancels read-modify-write mode and restores the contents of the column address register to their value prior to the receipt of the Read-Modify-Write command.



This command clears

- The display start line register.
- And set page address register to 3 page.

It does not power supply is turned on, a Reset signal is entered in the /RES pin. The Reset command cannot be used instead of this Reset signal.

10.2 Display Data RAM addressing

Page address		DATA					GX Y	Line address	Command	
D1	D(0			.)	OL CL	-Av	71		output
			DB0		14/1	17	141		00Н	COM 0
			DB1		\bullet $\chi \chi \chi$	4 /	I NIV		01H	COM 1
	1		DB2		$\Sigma V V$				02H	COM 2
			DB3		PAGE 0			03H	COM 3	
0	0		DB4	ALM	-	7.24			04H	COM 4
			DB5	(7)					05H	COM 5
			DB6			1 3/3			06Н	COM 6
			DB7			11/1/2			07H	COM 7
			DB0	1	71	8/1//			08H	COM 8
0	1		1.4		113	PAGE 1	:	:		
		111	DB7	4	- 75	7			0FH	COM15
	1	10	DB0		1/1				10H	COM16
1	0	1	:			:	:			
	1	1	DB7	U					17H	COM23
	10	1	DB0	1.4					18H	COM24
			DB1						19H	COM25
			DB2						1AH	COM26
			DB3	PAGE 3		1BH	COM27			
1	1		DB4					1CH	COM28	
			DB5						1DH	COM29
			DB6						1EH	COM30
			DB7	·					1FH	COM31
Column A		ADC	C D=0	00H	01H		4EH	4FH		
address			D=1	4FH	4EH		01H	00H		
			SEG pin	SEG 0	SEG1		SEG78	SEG79		

11. Initialization

- (a) Display off.
- (b) Display start line register: first line.
- (c) Static drive off.
- (d) Column address counter: Address 0.
- (e) Page address register: Page 0.
- (f) Select duty: 1/32.
- (g) Select ADC: Forward (ADC command d="0", ADC status flag = "1").
- (h) Read modify write off.

12. Reliability Condition

			TN Type		STN '	Туре	
			Normal Temp.	Wide Temp.	Normal Temp.	Wide Temp.	
Viewing	Horizontal Φ)	±30°	±30°	±30°	±30°	
Angle	Vertical ⊖(m	1)	10° to 30°	10° to 30°	-10 ° to 40 °	-10 ° to 40 °	
Operatin	g Temperature		-10 to 70°C	-25 to 80°C	0 to 50°C	*-20 to 70°C	
Storage Temperature			-20 to 80°C		*-30 to 80°C		
High Temper	rature (Power Of	f)	240 Hours 240 Hours 24		240 Hours	240 Hours	
			@70°C	@90°C	<u>@</u> 65°C	@75°C	
Low Temper	rature (Power Off	(240 Hours	240 Hours	240 Hours	240 Hours	
			@-20°C	@-35°C	@-15°C	@-25°C	
High Temperature (Power On)			240 Hours	240 Hours	240 Hours	240 Hours	
			@70°C	@80°C	@60°C	@70°C	
Low Temperature (Power On)			240 Hours	240 Hours	240 Hours	240 Hours	
			@-10°C	@-25°C	@-10°C	@-20°C	
High Temperature & High			55℃/90%RH	75°C/90%RH 45°C/90%RH		65°C/90%RH	
Humidity			240 Hours	240 Hours	240 Hours	240 Hours	
Thermal Shock	C C	C A 6		60min@-35°C	60min@-20°C	60min@-30°C	
5 Cycle	B	В	5min@25 °C	5min@25 °C	5min@25 °C	5min@25°C	
		С	60min@ 70°C	60min@90°C	60min@ 70°C	60min@80 °C	
Expected Lift			50,000 Hours	50,000 Hours 50,000 Hours		50,000 Hours	

^{*}Wide temp. version may not available for some products, Please consult our sales engineer or respresentative.

13. Functional Test & Inspection Criteria

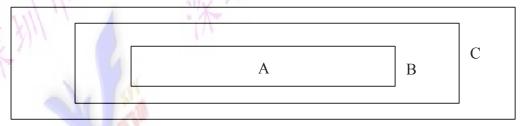
13.1 Sample plan

Sample plan according to MIL-STD-105D level 2, and acceptance/rejection criteria is. Base on : Major defect : AQL 0.65 Minor defect : AQL 2.5

13.2 Inspection condition

Viewing distance for cosmetic inspection is 30cm with bare eyes, and under an environment of 800 lus (20W) light intensity. All direction for inspecting the sample should be within 45° against perpendicular line.

13.3 Definition of Inspection Zone in LCD



Zone A: Character / Digit area

Zone B: Viewing area except Zone A (Zone A + Zone B = minimum Viewing area)
Zone C: Outside viewing area (invisible area after assembly in customer's product)

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and

assembly of customer's product.

13.4 Major Defect

All functional defects such as open (or missing segment), short, contrast differential, excess power consumption, smearing, leakage, etc. and overall outline dimension beyond the drawing. Are classified as major defects.

13.5 Minor Defect

Except the Major defects above, all cosmetic defects are classified as minor defects.

Item No.	Item to be Inspected	Inspection Standard				Classification of defects	
1.	Spot defect (Defects in spot from)	Zone size (mm) $\Phi \leq 0.15$		Acceptable (A B Acceptable (clutering of spot		C C Acceptable	Minor
		$0.15 \le \Phi \le 0.20$ $0.20 \le \Phi \le 0.25$ $\Phi > 0.25$		not allo	owed) 2 1 0	1	ST.
				white spot, size Φ is defined as			· (3)
2.	Line defect (Defects in line form)	$\begin{array}{c cccc} Size & (mm) \\ L & V \\ Length & Wi \\ Acceptable & \\ L \leq 3.0 & W \leq \\ L \geq 2.5 & W \leq \\ L \leq 3.0 & 0.03 < W \\ L \geq 2.5 & 0.03 < W \\ \end{array}$			A B Acceptable 2 0 Counted defect (item 1		Minor
3.	Orientation defect (such as misa lignment of L/C)	Shall not exceed four. Not allowed inside viewing area (Zone A or Zone B)				Minor	
4.	Polarizing	13.5.4.1 Polarizer Position 1. Shifting in Position Should not exceed the glass outline dimension. 2. Incomplete covering of the viewing area due to Shifting is not allowed. 13.5.4.2 Seratches, bubble or dent on Glass/Polarizer/Reflector, Bubble between Polarizer & Reflector/Glass: Size (mm) Acceptable Qty Zone A B C Φ ≤ 0.20 Acceptable Acceptable 0.20<Φ ≤ 0.50 3 table 0.50<Φ ≤ 1.00 Φ>1.00 0				Minor	